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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-8FX
Core Size	8-Bit
Speed	16MHz
Connectivity	LINbus, SIO, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	17
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	240 x 8
Voltage - Supply (Vcc/Vdd)	2.4V ~ 5.5V
Data Converters	A/D 6x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb95f262kpft-g-103-sne2

1. Product Line-up

MB95260H Series

Part number / Parameter	MB95F262H	MB95F263H	MB95F264H	MB95F262K	MB95F263K	MB95F264K
Type	Flash memory product					
Clock supervisor counter	It supervises the main clock oscillation.					
Flash memory capacity	8 Kbyte	12 Kbyte	20 Kbyte	8 Kbyte	12 Kbyte	20 Kbyte
RAM capacity	240 bytes	496 bytes	496 bytes	240 bytes	496 bytes	496 bytes
Power-on reset	Yes					
Low-voltage detection reset	No			Yes		
Reset input	Dedicated			Selected by software		
CPU functions	• Number of basic instructions : 136 • Instruction bit length : 8 bits • Instruction length : 1 to 3 bytes • Data bit length : 1, 8 and 16 bits • Minimum instruction execution time : 61.5 ns (machine clock frequency = 16.25 MHz) • Interrupt processing time : 0.6 µs (machine clock frequency = 16.25 MHz)					
General-purpose I/O	• I/O ports (Max) : 16 • CMOS I/O : 15 • N-ch open drain : 1			• I/O ports (Max) : 17 • CMOS I/O : 15 • N-ch open drain : 2		
Time-base timer	Interval time: 0.256 ms to 8.3 s (external clock frequency = 4 MHz)					
Hardware/software watchdog timer	• Reset generation cycle Main oscillation clock at 10 MHz: 105 ms (Min) • The sub CR clock can be used as the source clock of the hardware watchdog timer.					
Wild register	It can be used to replace three bytes of data.					
LIN-UART	• A wide range of communication speed can be selected by a dedicated reload timer. • It has a full duplex double buffer. • Clock-synchronized serial data transfer and clock-asynchronized serial data transfer is enabled. • The LIN function can be used as a LIN master or a LIN slave.					
8/10-bit A/D converter	6 channels					
	8-bit or 10-bit resolution can be selected.					
8/16-bit composite timer	2 channels					
	• The timer can be configured as an "8-bit timer × 2 channels" or a "16-bit timer × 1 channel". • It has built-in timer function, PWC function, PWM function and input capture function. • Count clock: it can be selected from internal clocks (seven types) and external clocks. • It can output square wave.					
External interrupt	6 channels					
	• Interrupt by edge detection (The rising edge, falling edge, or both edges can be selected.) • It can be used to wake up the device from the standby mode.					
On-chip debug	• 1-wire serial control • It supports serial writing. (asynchronous mode)					

(Continued)

MB95270H Series

Part number / Parameter	MB95F272H	MB95F273H	MB95F274H	MB95F272K	MB95F273K	MB95F274K
Type	Flash memory product					
Clock supervisor counter	It supervises the main clock oscillation.					
Flash memory capacity	8 Kbyte	12 Kbyte	20 Kbyte	8 Kbyte	12 Kbyte	20 Kbyte
RAM capacity	240 bytes	496 bytes	496 bytes	240 bytes	496 bytes	496 bytes
Power-on reset	Yes					
Low-voltage detection reset	No			Yes		
Reset input	Dedicated			Selected by software		
CPU functions	• Number of basic instructions : 136 • Instruction bit length : 8 bits • Instruction length : 1 to 3 bytes • Data bit length : 1, 8 and 16 bits • Minimum instruction execution time : 61.5 ns (machine clock frequency = 16.25 MHz) • Interrupt processing time : 0.6 µs (machine clock frequency = 16.25 MHz)					
General-purpose I/O	• I/O ports (Max) : 4 • CMOS I/O : 3 • N-ch open drain : 1			• I/O ports (Max) : 5 • CMOS I/O : 3 • N-ch open drain : 2		
Time-base timer	Interval time: 0.256 ms to 8.3 s (external clock frequency = 4 MHz)					
Hardware/software watchdog timer	• Reset generation cycle Main oscillation clock at 10 MHz: 105 ms (Min) • The sub-internal CR clock can be used as the source clock of the hardware watchdog timer.					
Wild register	It can be used to replace three bytes of data.					
LIN-UART	No LIN-UART					
8/10-bit A/D converter	2 channels					
	8-bit or 10-bit resolution can be selected.					
8/16-bit composite timer	1 channel					
	• The timer can be configured as an "8-bit timer × 2 channels" or a "16-bit timer × 1 channel". • It has built-in timer function, PWC function, PWM function and input capture function. • Count clock: it can be selected from internal clocks (seven types) and external clocks. • It can output square wave.					
External interrupt	2 channels					
	• Interrupt by edge detection (The rising edge, falling edge, or both edges can be selected.) • It can be used to wake up the device from standby modes.					
On-chip debug	• 1-wire serial control • It supports serial writing. (asynchronous mode)					
Watch prescaler	Eight different time intervals can be selected.					
Flash memory	• It supports automatic programming, Embedded Algorithm, program/erase/erase-suspend/erase-resume commands. • It has a flag indicating the completion of the operation of Embedded Algorithm. • Number of program/erase cycles: 100000 • Data retention time: 20 years • Flash security feature for protecting the content of the Flash memory					
Standby mode	Sleep mode, stop mode, watch mode, time-base timer mode					
Package	DIP-8P-M03 FPT-8P-M08					

2. Packages and Corresponding Products

Package \ Part number	MB95F262H	MB95F262K	MB95F263H	MB95F263K	MB95F264H	MB95F264K	MB95F272H	MB95F272K	MB95F273H	MB95F273K	MB95F274H	MB95F274K
DIP-24P-M07	O	O	O	O	O	O	X	X	X	X	X	X
FPT-20P-M09	O	O	O	O	O	O	X	X	X	X	X	X
FPT-20P-M10	O	O	O	O	O	O	X	X	X	X	X	X
DIP-16P-M06	X	X	X	X	X	X	X	X	X	X	X	X
FPT-16P-M06	X	X	X	X	X	X	X	X	X	X	X	X
DIP-8P-M03	X	X	X	X	X	X	O	O	O	O	O	O
FPT-8P-M08	X	X	X	X	X	X	O	O	O	O	O	O
LCC-32P-M19	O	O	O	O	O	O	X	X	X	X	X	X

Package \ Part number	MB95F282H	MB95F282K	MB95F283H	MB95F283K	MB95F284H	MB95F284K
DIP-24P-M07	X	X	X	X	X	X
FPT-20P-M09	X	X	X	X	X	X
FPT-20P-M10	X	X	X	X	X	X
DIP-16P-M06	O	O	O	O	O	O
FPT-16P-M06	O	O	O	O	O	O
DIP-8P-M03	X	X	X	X	X	X
FPT-8P-M08	X	X	X	X	X	X
LCC-32P-M19	O	O	O	O	O	O

O: Available

X: Unavailable

8. Pin Description (MB95270H Series, 8 pins)

Pin no.	Pin name	I/O circuit type*	Function
1	V_{SS}	—	Power supply pin (GND)
2	V_{CC}	—	Power supply pin
3	C	—	Capacitor connection pin
4	PF2	A	General-purpose I/O port
	$\overline{RST}$		Reset pin This pin is a dedicated reset pin in MB95F272H/F273H/F274H.
5	P04	F	General-purpose I/O port
	INT04		External interrupt input pin
	AN04		A/D converter analog input pin
	EC0		8/16-bit composite timer ch. 0 clock input pin
6	P05	E	General-purpose I/O port High-current pin
	AN05		A/D converter analog input pin
	TO00		8/16-bit composite timer ch. 0 output pin
7	P06	G	General-purpose I/O port High-current pin
	INT06		External interrupt input pin
	TO01		8/16-bit composite timer ch. 0 output pin
8	P12	H	General-purpose I/O port
	EC0		8/16-bit composite timer ch. 0 clock input pin
	DBG		DBG input pin

*: For the I/O circuit types, see “11. I/O Circuit Type”.

(Continued)

Pin no.	Pin name	I/O circuit type*	Function
21	P05	E	General-purpose I/O port High-current pin
	INT05		External interrupt input pin
	AN05		A/D converter analog input pin
	TO00		8/16-bit composite timer ch. 0 output pin
22	P06	G	General-purpose I/O port High-current pin
	INT06		External interrupt input pin
	TO01		8/16-bit composite timer ch. 0 output pin
23	P12	H	General-purpose I/O port
	EC0		8/16-bit composite timer ch. 0 clock input pin
	DBG		DBG input pin
24	P07	G	General-purpose I/O port
	INT07		External interrupt input pin
25	NC	—	It is an internally connected pin. Always leave it unconnected.
26	NC	—	It is an internally connected pin. Always leave it unconnected.
27	NC	—	It is an internally connected pin. Always leave it unconnected.
28	NC	—	It is an internally connected pin. Always leave it unconnected.
29	NC	—	It is an internally connected pin. Always leave it unconnected.
30	NC	—	It is an internally connected pin. Always leave it unconnected.
31	NC	—	It is an internally connected pin. Always leave it unconnected.
32	NC	—	It is an internally connected pin. Always leave it unconnected.

*: For the I/O circuit types, see “11. I/O Circuit Type”.

12. Notes on Device Handling

Preventing latch-ups

When using the device, ensure that the voltage applied does not exceed the maximum voltage rating.

In a CMOS IC, if a voltage higher than V_{CC} or a voltage lower than V_{SS} is applied to an input/output pin that is neither a medium-withstand voltage pin nor a high-withstand voltage pin, or if a voltage out of the rating range of power supply voltage mentioned in “24.1 Absolute Maximum Ratings” of “24. Electrical Characteristics” is applied to the V_{CC} pin or the V_{SS} pin, a latch-up may occur.

When a latch-up occurs, power supply current increases significantly, which may cause a component to be thermally destroyed.

Stabilizing supply voltage

Supply voltage must be stabilized.

A malfunction may occur when power supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the V_{CC} power supply voltage.

As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in V_{CC} ripple (p-p value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the standard V_{CC} value, and the transient fluctuation rate does not exceed 0.1 V/ms at a momentary fluctuation such as switching the power supply.

Notes on using the external clock

When an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

13. Pin Connection

Treatment of unused pins

If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least 2 kΩ. Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.

Power supply pins

To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the V_{CC} pin and the V_{SS} pin to the power supply and ground outside the device. In addition, connect the current supply source to the V_{CC} pin and the V_{SS} pin with low impedance.

It is also advisable to connect a ceramic capacitor of approximately 0.1 µF as a bypass capacitor between the V_{CC} pin and the V_{SS} pin at a location close to this device.

DBG pin

Connect the DBG pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the debug mode due to noise, minimize the distance between the DBG pin and the V_{CC} or V_{SS} pin when designing the layout of the printed circuit board.

The DBG pin should not stay at “L” level after power-on until the reset output is released.

$\overline{\text{RST}}$ pin

Connect the $\overline{\text{RST}}$ pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the reset mode due to noise, minimize the distance between the $\overline{\text{RST}}$ pin and the V_{CC} or V_{SS} pin when designing the layout of the printed circuit board.

The PF2/$\overline{\text{RST}}$ pin functions as the reset input/output pin after power-on. In addition, the reset output of the PF2/$\overline{\text{RST}}$ pin can be enabled by the RSTOE bit of the SYSC register, and the reset input function and the general purpose I/O function can be selected by the RSTEN bit of the SYSC register.

Address	Register abbreviation	Register name	R/W	Initial value
$0F81_H$	WRARL0	Wild register address setting register (Lower) ch. 0	R/W	00000000_B
$0F82_H$	WRDR0	Wild register data setting register ch. 0	R/W	00000000_B
$0F83_H$	WRARH1	Wild register address setting register (Upper) ch. 1	R/W	00000000_B
$0F84_H$	WRARL1	Wild register address setting register (Lower) ch. 1	R/W	00000000_B
$0F85_H$	WRDR1	Wild register data setting register ch. 1	R/W	00000000_B
$0F86_H$	WRARH2	Wild register address setting register (Upper) ch. 2	R/W	00000000_B
$0F87_H$	WRARL2	Wild register address setting register (Lower) ch. 2	R/W	00000000_B
$0F88_H$	WRDR2	Wild register data setting register ch. 2	R/W	00000000_B
$0F89_H$ to $0F91_H$	—	(Disabled)	—	—
$0F92_H$	T01CR0	8/16-bit composite timer 01 status control register 0 ch. 0	R/W	00000000_B
$0F93_H$	T00CR0	8/16-bit composite timer 00 status control register 0 ch. 0	R/W	00000000_B
$0F94_H$	T01DR	8/16-bit composite timer 01 data register ch. 0	R/W	00000000_B
$0F95_H$	T00DR	8/16-bit composite timer 00 data register ch. 0	R/W	00000000_B
$0F96_H$	TMCR0	8/16-bit composite timer 00/01 timer mode control register ch. 0	R/W	00000000_B
$0F97_H$	T11CR0	8/16-bit composite timer 11 status control register 0 ch. 1	R/W	00000000_B
$0F98_H$	T10CR0	8/16-bit composite timer 10 status control register 0 ch. 1	R/W	00000000_B
$0F99_H$	T11DR	8/16-bit composite timer 11 data register ch. 1	R/W	00000000_B
$0F9A_H$	T10DR	8/16-bit composite timer 10 data register ch. 1	R/W	00000000_B
$0F9B_H$	TMCR1	8/16-bit composite timer 10/11 timer mode control register ch. 1	R/W	00000000_B
$0F9C_H$ to $0FBB_H$	—	(Disabled)	—	—
$0FBC_H$	BGR1	LIN-UART baud rate generator register 1	R/W	00000000_B
$0FBD_H$	BGR0	LIN-UART baud rate generator register 0	R/W	00000000_B
$0FBE_H$ to $0FC2_H$	—	(Disabled)	—	—
$0FC3_H$	AIDRL	A/D input disable register (Lower)	R/W	00000000_B
$0FC4_H$ to $0FE3_H$	—	(Disabled)	—	—
$0FE4_H$	CRTH	Main CR clock trimming register (Upper)	R/W	$1XXXXXXX_B$
$0FE5_H$	CRTL	Main CR clock trimming register (Lower)	R/W	$000XXXXX_B$

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Address	Register abbreviation	Register name	R/W	Initial value
$0FE6_H$, $0FE7_H$	—	(Disabled)	—	—
$0FE8_H$	SYSC	System configuration register	R/W	11000011_B
$0FE9_H$	CMCR	Clock monitoring control register	R/W	00000000_B
$0FEA_H$	CMDR	Clock monitoring data register	R/W	00000000_B
$0FEB_H$	WDTH	Watchdog timer selection ID register (Upper)	R/W	$XXXXXXXX_B$
$0FEC_H$	WDTL	Watchdog timer selection ID register (Lower)	R/W	$XXXXXXXX_B$
$0FED_H$	—	(Disabled)	—	—
$0FEE_H$	ILSR	Input level select register	R/W	00000000_B
$0FEF_H$ to $0FFF_H$	—	(Disabled)	—	—

R/W access symbols

R/W : Readable / Writable

R : Read only

Initial value symbols

0 : The initial value of this bit is “0”.

1 : The initial value of this bit is “1”.

X : The initial value of this bit is undefined.

Note: Do not write to an address that is “(Disabled)”. If a “(Disabled)” address is read, an indeterminate value is returned.

19. I/O Map (MB95270H Series)

Address	Register abbreviation	Register name	R/W	Initial value
0000_H	PDR0	Port 0 data register	R/W	00000000_B
0001_H	DDR0	Port 0 direction register	R/W	00000000_B
0002_H	PDR1	Port 1 data register	R/W	00000000_B
0003_H	DDR1	Port 1 direction register	R/W	00000000_B
0004_H	—	(Disabled)	—	—
0005_H	WATR	Oscillation stabilization wait time setting register	R/W	11111111_B
0006_H	—	(Disabled)	—	—
0007_H	SYCC	System clock control register	R/W	$0000X011_B$
0008_H	STBC	Standby control register	R/W	$00000XXX_B$
0009_H	RSRR	Reset source register	R/W	$000XXXXX_B$
$000A_H$	TBTC	Time-base timer control register	R/W	00000000_B
$000B_H$	WPCR	Watch prescaler control register	R/W	00000000_B
$000C_H$	WDTC	Watchdog timer control register	R/W	$00XX0000_B$
$000D_H$	SYCC2	System clock control register 2	R/W	$XX100011_B$
$000E_H$ to 0015_H	—	(Disabled)	—	—
0016_H	—	(Disabled)	—	—
0017_H	—	(Disabled)	—	—
0018_H to 0027_H	—	(Disabled)	—	—
0028_H	PDRF	Port F data register	R/W	00000000_B
0029_H	DDRF	Port F direction register	R/W	00000000_B
$002A_H$	—	(Disabled)	—	—
$002B_H$	—	(Disabled)	—	—
$002C_H$	PUL0	Port 0 pull-up register	R/W	00000000_B
$002D_H$ to 0034_H	—	(Disabled)	—	—
0035_H	—	(Disabled)	—	—
0036_H	T01CR1	8/16-bit composite timer 01 status control register 1 ch. 0	R/W	00000000_B
0037_H	T00CR1	8/16-bit composite timer 00 status control register 1 ch. 0	R/W	00000000_B
0038_H	—	(Disabled)	—	—
0039_H	—	(Disabled)	—	—
$003A_H$ to 0048_H	—	(Disabled)	—	—
0049_H	—	(Disabled)	—	—

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Address	Register abbreviation	Register name	R/W	Initial value
$0FE9_H$	CMCR	Clock monitoring control register	R/W	00000000_B
$0FEA_H$	CMDR	Clock monitoring data register	R/W	00000000_B
$0FEB_H$	WDTH	Watchdog timer selection ID register (Upper)	R/W	$XXXXXXXX_B$
$0FEC_H$	WDTL	Watchdog timer selection ID register (Lower)	R/W	$XXXXXXXX_B$
$0FED_H$	—	(Disabled)	—	—
$0FEE_H$	ILSR	Input level select register	R/W	00000000_B
$0FEF_H$ to $0FFF_H$	—	(Disabled)	—	—

R/W access symbols

R/W : Readable / Writable

R : Read only

Initial value symbols

0 : The initial value of this bit is “0”.

1 : The initial value of this bit is “1”.

X : The initial value of this bit is undefined.

Note: Do not write to an address that is “(Disabled)”. If a “(Disabled)” address is read, an indeterminate value is returned.

22. Interrupt Source Table (MB95270H Series)

Interrupt source	Interrupt request number	Vector table address		Bit name of interrupt level setting register	Priority order of interrupt sources of the same level (occurring simultaneously)
		Upper	Lower		
External interrupt ch. 4	IRQ00	$FFFA_H$	$FFFB_H$	L00 [1:0]	High
—	IRQ01	$FFF8_H$	$FFF9_H$	L01 [1:0]	
—	IRQ02	$FFF6_H$	$FFF7_H$	L02 [1:0]	
External interrupt ch. 6					
—	IRQ03	$FFF4_H$	$FFF5_H$	L03 [1:0]	
—					
—	IRQ04	$FFF2_H$	$FFF3_H$	L04 [1:0]	
8/16-bit composite timer ch. 0 (Lower)	IRQ05	$FFF0_H$	$FFF1_H$	L05 [1:0]	
8/16-bit composite timer ch. 0 (Upper)	IRQ06	$FFEE_H$	$FFEF_H$	L06 [1:0]	
—	IRQ07	$FFEC_H$	$FFED_H$	L07 [1:0]	
—	IRQ08	$FFEA_H$	$FFEB_H$	L08 [1:0]	
—	IRQ09	$FFE8_H$	$FFE9_H$	L09 [1:0]	
—	IRQ10	$FFE6_H$	$FFE7_H$	L10 [1:0]	
—	IRQ11	$FFE4_H$	$FFE5_H$	L11 [1:0]	
—	IRQ12	$FFE2_H$	$FFE3_H$	L12 [1:0]	
—	IRQ13	$FFE0_H$	$FFE1_H$	L13 [1:0]	
—	IRQ14	$FFDE_H$	$FFDF_H$	L14 [1:0]	
—	IRQ15	$FFDC_H$	$FFDD_H$	L15 [1:0]	
—	IRQ16	$FFDA_H$	$FFDB_H$	L16 [1:0]	
—	IRQ17	$FFD8_H$	$FFD9_H$	L17 [1:0]	
8/10-bit A/D converter	IRQ18	$FFD6_H$	$FFD7_H$	L18 [1:0]	
Time-base timer	IRQ19	$FFD4_H$	$FFD5_H$	L19 [1:0]	
Watch prescaler	IRQ20	$FFD2_H$	$FFD3_H$	L20 [1:0]	
—	IRQ21	$FFD0_H$	$FFD1_H$	L21 [1:0]	
—	IRQ22	$FFCE_H$	$FFCF_H$	L22 [1:0]	
Flash memory	IRQ23	$FFCC_H$	$FFCD_H$	L23 [1:0]	Low

23. Interrupt Source Table (MB95280H Series)

Interrupt source	Interrupt request number	Vector table address		Bit name of interrupt level setting register	Priority order of interrupt sources of the same level (occurring simultaneously)
		Upper	Lower		
External interrupt ch. 4	IRQ00	$FFFA_H$	$FFFB_H$	L00 [1:0]	High
External interrupt ch. 5	IRQ01	$FFF8_H$	$FFF9_H$	L01 [1:0]	
External interrupt ch. 2	IRQ02	$FFF6_H$	$FFF7_H$	L02 [1:0]	
External interrupt ch. 6					
External interrupt ch. 3	IRQ03	$FFF4_H$	$FFF5_H$	L03 [1:0]	
External interrupt ch. 7					
—	IRQ04	$FFF2_H$	$FFF3_H$	L04 [1:0]	
8/16-bit composite timer ch. 0 (Lower)	IRQ05	$FFF0_H$	$FFF1_H$	L05 [1:0]	
8/16-bit composite timer ch. 0 (Upper)	IRQ06	$FFEE_H$	$FFEF_H$	L06 [1:0]	
LIN-UART (reception)	IRQ07	$FFEC_H$	$FFED_H$	L07 [1:0]	
LIN-UART (transmission)	IRQ08	$FFEA_H$	$FFEB_H$	L08 [1:0]	
—	IRQ09	$FFE8_H$	$FFE9_H$	L09 [1:0]	
—	IRQ10	$FFE6_H$	$FFE7_H$	L10 [1:0]	
—	IRQ11	$FFE4_H$	$FFE5_H$	L11 [1:0]	
—	IRQ12	$FFE2_H$	$FFE3_H$	L12 [1:0]	
—	IRQ13	$FFE0_H$	$FFE1_H$	L13 [1:0]	
—	IRQ14	$FFDE_H$	$FFDF_H$	L14 [1:0]	
—	IRQ15	$FFDC_H$	$FFDD_H$	L15 [1:0]	
—	IRQ16	$FFDA_H$	$FFDB_H$	L16 [1:0]	
—	IRQ17	$FFD8_H$	$FFD9_H$	L17 [1:0]	
8/10-bit A/D converter	IRQ18	$FFD6_H$	$FFD7_H$	L18 [1:0]	
Time-base timer	IRQ19	$FFD4_H$	$FFD5_H$	L19 [1:0]	
Watch prescaler	IRQ20	$FFD2_H$	$FFD3_H$	L20 [1:0]	
—	IRQ21	$FFD0_H$	$FFD1_H$	L21 [1:0]	
—	IRQ22	$FFCE_H$	$FFCF_H$	L22 [1:0]	
Flash memory	IRQ23	$FFCC_H$	$FFCD_H$	L23 [1:0]	Low

(Continued)

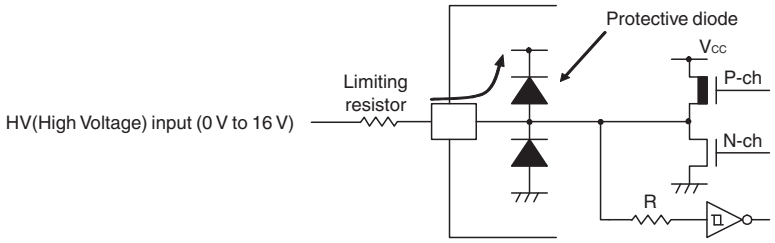
*1: These parameters are based on the condition that V_{SS} is 0.0 V.

*2: V_I and V_O must not exceed V_{CC} + 0.3 V. V_I must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the I_{CLAMP} rating is used instead of the V_I rating.

*3: Applicable to the following pins: P00 to P07, P62 to P64, PG1, PG2, PF0, PF1 (P00, P62, P63 and P64 are only available on MB95F262H/F262K/F263H/F263K/F264H/F264K. P01, P02, P03, P07, PG1, PG2, PF0 and PF1 are only available on MB95F262H/F262K/F263H/F263K/F264H/F264K/F282H/F282K/F283H/F283K/F284H/F284K.)

- Use under recommended operating conditions.
- Use with DC voltage (current).
- The HV (High Voltage) signal is an input signal exceeding the V_{CC} voltage. Always connect a limiting resistor between the HV (High Voltage) signal and the microcontroller before applying the HV (High Voltage) signal.
- The value of the limiting resistor should be set to a value at which the current to be input to the microcontroller pin when the HV (High Voltage) signal is input is below the standard value, irrespective of whether the current is transient current or stationary current.
- When the microcontroller drive current is low, such as in low power consumption modes, the HV (High Voltage) input potential may pass through the protective diode to increase the potential of the V_{CC} pin, affecting other devices.
- If the HV (High Voltage) signal is input when the microcontroller power supply is off (not fixed at 0 V), since power is supplied from the pins, incomplete operations may be executed.
- If the HV (High Voltage) input is input after power-on, since power is supplied from the pins, the voltage of power supply may not be sufficient to enable a power-on reset.
- Do not leave the HV (High Voltage) input pin unconnected.
- Example of a recommended circuit:

Input/Output equivalent circuit



*4: P62 and P63 are only available on MB95F262H/F262K/F263H/F263K/F264H/F264K.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

24.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = 0.0 V, T_A = -40°C to + 85°C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IHI}	P04	*1	0.7 V_{CC}	—	V_{CC} + 0.3	V	When CMOS input level (hysteresis input) is selected
	V_{IHS}	P00 to P07, P12, P62 to P64, PF0, PF1, PG1, PG2	*1	0.8 V_{CC}	—	V_{CC} + 0.3	V	Hysteresis input
	V_{IHM}	PF2	—	0.7 V_{CC}	—	V_{CC} + 0.3	V	Hysteresis input
"L" level input voltage	V_{IL}	P04	*1	V_{SS} - 0.3	—	0.3 V_{CC}	V	When CMOS input level (hysteresis input) is selected
	V_{ILS}	P00 to P07, P12, P62 to P64, PF0, PF1, PG1, PG2	*1	V_{SS} - 0.3	—	0.2 V_{CC}	V	Hysteresis input
	V_{ILM}	PF2	—	V_{SS} - 0.3	—	0.3 V_{CC}	V	Hysteresis input
Open-drain output application voltage	V_D	PF2, P12	—	V_{SS} - 0.3	—	V_{SS} + 5.5	V	
"H" level output voltage	V_{OH1}	Output pins other than P05, P06, P12, P62, P63, PF2*2	I_{OH} = - 4 mA	V_{CC} - 0.5	—	—	V	
	V_{OH2}	P05, P06, P62, P63*2	I_{OH} = - 8 mA	V_{CC} - 0.5	—	—	V	
"L" level output voltage	V_{OL1}	Output pins other than P05, P06, P62, P63*2	I_{OL} = 4 mA	—	—	0.4	V	
	V_{OL2}	P05, P06, P62, P63*2	I_{OL} = 12 mA	—	—	0.4	V	
Input leak current (Hi-Z output leak current)	I_{LI}	All input pins	0.0 V < V_I < V_{CC}	- 5	—	+ 5	µA	When pull-up resistance is disabled
Pull-up resistance	R_{PULL}	P00 to P07, PG1, PG2*3*4	V_I = 0 V	25	50	100	kΩ	When pull-up resistance is enabled
Input capacitance	C_{IN}	Other than V_{CC} and V_{SS}	f = 1 MHz	—	5	15	pF	

(Continued)

24.4 AC Characteristics

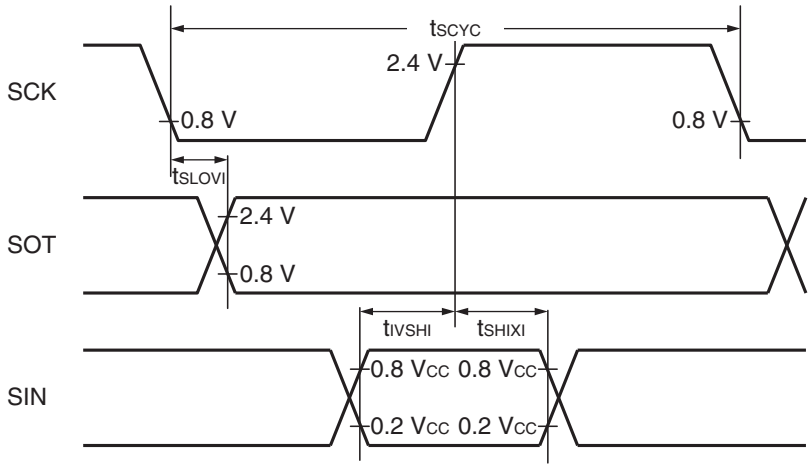
24.4.1 Clock Timing

(V_{CC} = 2.4 V to 5.5 V, V_{SS} = 0.0 V, T_A = -40°C to + 85°C)

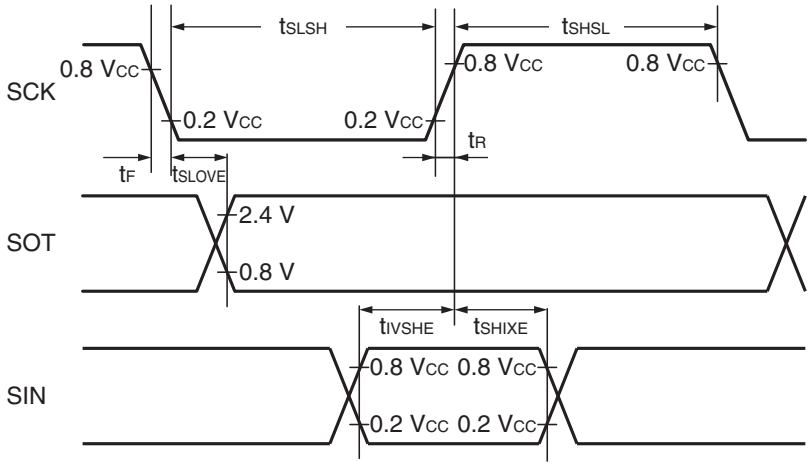
Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F_{CH}	X0, X1	—	1	—	16.25	MHz	When the main oscillation circuit is used
		X0	X1 : open	1	—	12	MHz	When the main external clock is used
		X0, X1	*1	1	—	32.5	MHz	
	F_{CRH}	—	—	9.7	10	10.3	MHz	When the main CR clock is used*2 3.3 V ≤ Vcc ≤ 5.5 V(-40 °C ≤ T_A ≤ + 40 °C) 2.4 V ≤ Vcc < 3.3 V(0 °C ≤ T_A ≤ + 40 °C)
				7.76	8	8.24	MHz	
				0.97	1	1.03	MHz	
				9.55	10	10.45	MHz	When the main CR clock is used*2 3.3 V ≤ Vcc ≤ 5.5 V (+ 40 °C < T_A ≤ + 85 °C)
				7.64	8	8.36	MHz	
				0.955	1	1.045	MHz	
				9.5	10	10.5	MHz	When the main CR clock is used*2 2.4 V≤ Vcc < 3.3 V (-40 °C ≤ T_A < 0 °C, + 40 °C < T_A ≤ + 85 °C)
				7.6	8	8.4	MHz	
				0.95	1	1.05	MHz	
				9.7	10	10.3	MHz	When the main CR clock is used*3 2.4 V ≤ Vcc ≤ 5.5 V(0 °C ≤ T_A ≤ + 40 °C)
				7.76	8	8.24	MHz	
				0.97	1	1.03	MHz	
				9.5	10	10.5	MHz	When the main CR clock is used*3 2.4 V ≤ Vcc ≤ 5.5 V (-40 °C ≤ T_A < 0 °C, ＋40 °C < T_A ≤＋85 °C)
				7.6	8	8.4	MHz	
				0.95	1	1.05	MHz	
	F_{CL}	X0A, X1A	—	—	32.768	—	kHz	When the sub oscillation circuit is used
				—	32.768	—	kHz	When the sub-external clock is used
	F_{CRL}	—	—	50	100	200	kHz	When the sub CR clock is used
Clock cycle time	t_{HCYL}	X0, X1	—	61.5	—	1000	ns	When the main oscillation circuit is used
		X0	X1 : open	83.4	—	1000	ns	When the external clock is used
		X0, X1	*1	30.8	—	1000	ns	
	t_{LCYL}	X0A, X1A	—	—	30.5	—	µs	When the subclock is used

(Continued)

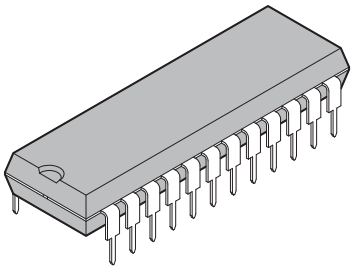
Internal shift clock mode



External shift clock mode

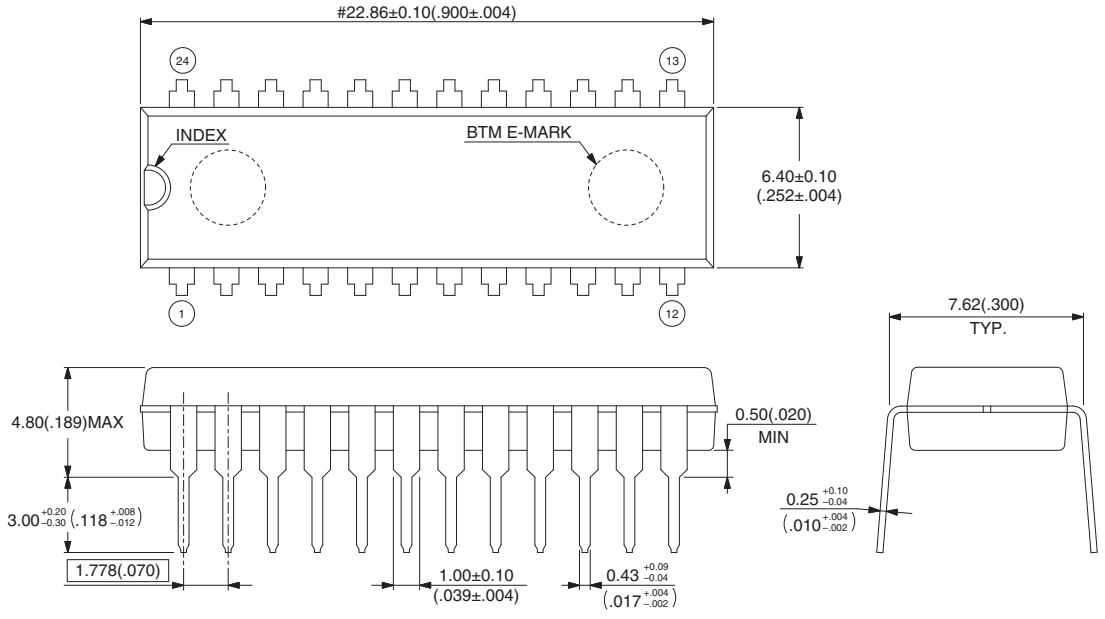


28. Package Dimension

24-pin plastic SDIP		
 (DIP-24P-M07)	Lead pitch	1.778 mm
	Package width × package length	6.40 mm × 22.86 mm
	Sealing method	Plastic mold
	Mounting height	4.80 mm Max

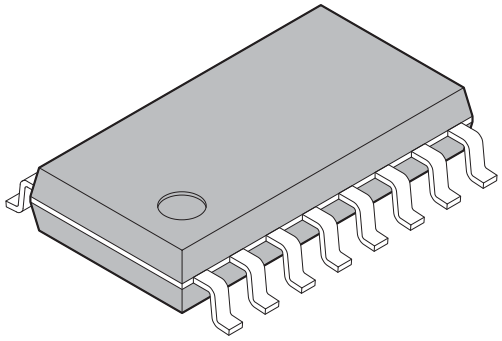
24-pin plastic SDIP
(DIP-24P-M07)

Note 1) Pins width and pins thickness include plating thickness.
Note 2) Pins width do not include tie bar cutting remainder.
Note 3) # : These dimensions do not include resin protrusion.



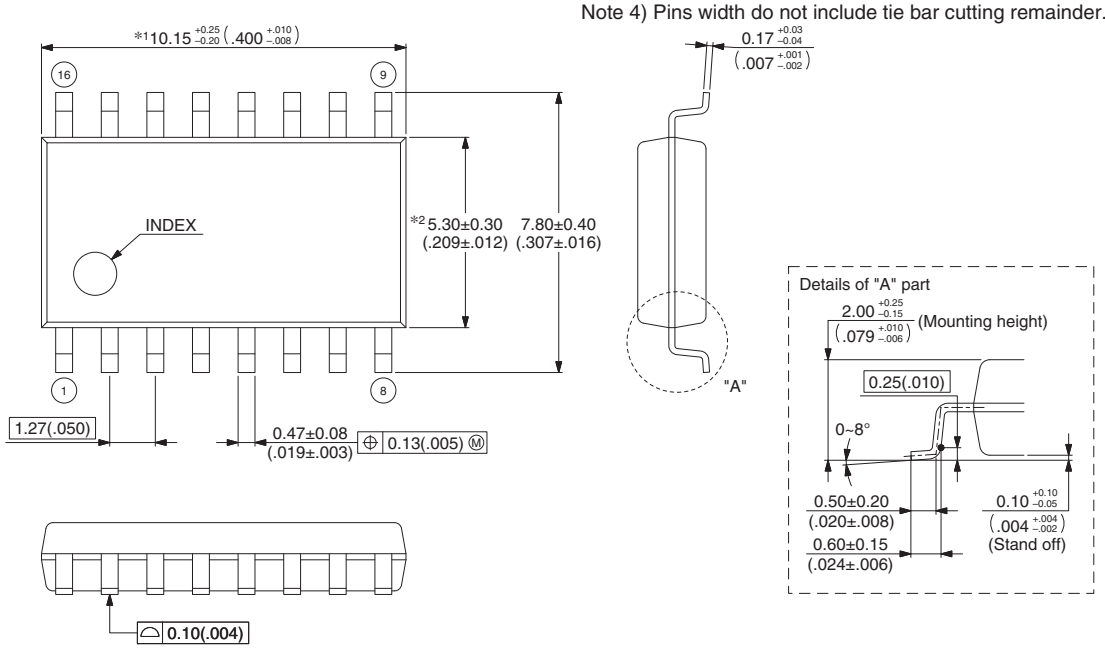
Dimensions in mm (inches).
Note: The values in parentheses are reference values

(Continued)

16-pin plastic SOP		
	Lead pitch	1.27 mm
	Package width × package length	5.3 × 10.15 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	2.25 mm MAX
	Weight	0.20 g
(FPT-16P-M06)	Code (Reference)	P-SOP16-5.3×10.15-1.27

16-pin plastic SOP
(FPT-16P-M06)

Note 1) *1 : These dimensions include resin protrusion.
Note 2) *2 : These dimensions do not include resin protrusion.
Note 3) Pins width and pins thickness include plating thickness.
Note 4) Pins width do not include tie bar cutting remainder.



Dimensions in mm (inches).
Note: The values in parentheses are reference values.

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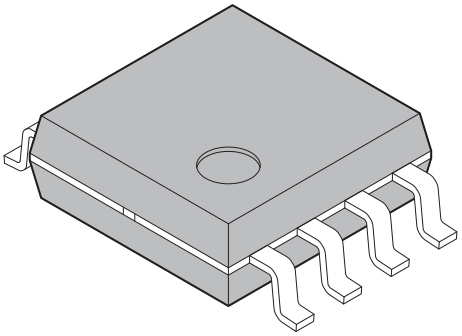
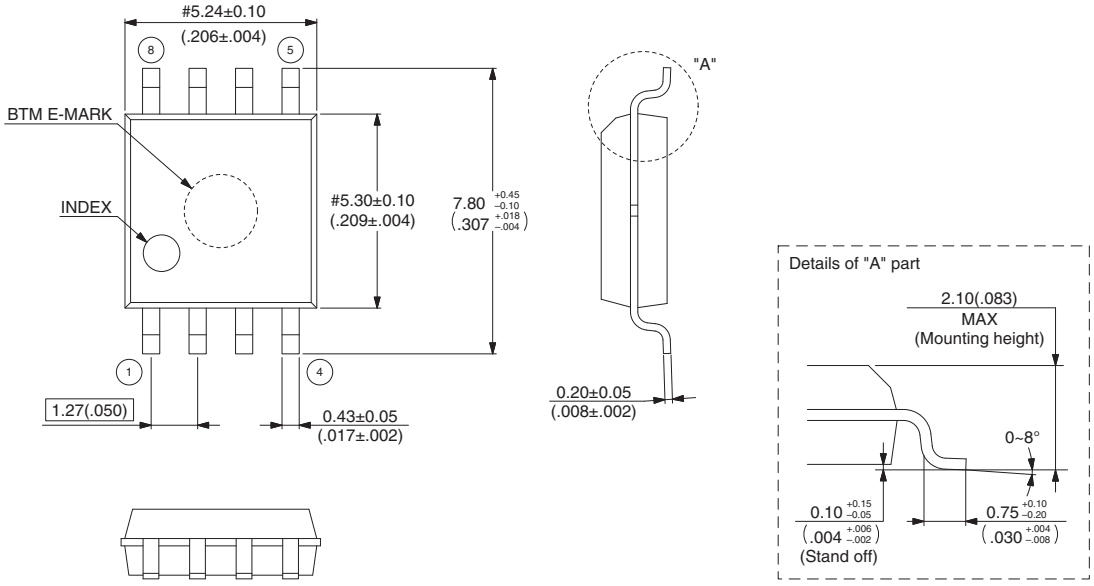
8-pin plastic SOP		
 (FPT-8P-M08)	Lead pitch	1.27 mm
	Package width × package length	5.30 mm × 5.24 mm
	Lead shape	Gullwing
	Lead bend direction	Normal bend
	Sealing method	Plastic mold
	Mounting height	2.10 mm Max

8-pin plastic SOP
(FPT-8P-M08)

Note 1) Pins width and pins thickness include plating thickness.
Note 2) Pins width do not include tie bar cutting remainder.
Note 3) # : These dimensions do not include resin protrusion.



Dimensions in mm (inches).
Note: The values in parentheses are reference values.

29. Major Changes

Spansion Publication Number: DS07–12627–7E

Page	Section	Details
1	—	Changed the family name. F^2MC-8FX → New 8FX
2	Features	Added “• Power-on reset”.
3	Product Line-up MB95260H Series	Added the parameter “Power-on reset”.
5	Product Line-up MB95270H Series	Added the parameter “Power-on reset”.
6	Product Line-up MB95280H Series	Added the parameter “Power-on reset”.
10	Pin Assignment	Deleted the HCLK1 pin and the HCLK2 pin.
11		Deleted the HCLK1 pin and the HCLK2 pin.
13	Pin Description (MB95260H Series, 32 pins)	Deleted the HCLK1 pin and the HCLK2 pin.
15	Pin Description (MB95260H Series, 24 pins)	Deleted the HCLK1 pin and the HCLK2 pin.
17	Pin Description (MB95260H Series, 20 pins)	Deleted the HCLK1 pin and the HCLK2 pin.
18	Pin Description (MB95270H Series, 8 pins)	Deleted the HCLK1 pin and the HCLK2 pin.
19	Pin Description (MB95280H Series, 32 pins)	Deleted the HCLK1 pin.
20		Deleted the HCLK2 pin.
21	Pin Description (MB95280H Series, 16 pins)	Deleted the HCLK1 pin.
22		Deleted the HCLK2 pin.
27	Block Diagram (MB95260H Series)	Deleted the HCLK1 pin and the HCLK2 pin.
28	Block Diagram (MB95270H Series)	Deleted the HCLK1 pin and the HCLK2 pin.
29	Block Diagram (MB95280H Series)	Deleted the HCLK1 pin and the HCLK2 pin.
52, 53	Electrical Characteristics 4. AC Characteristics (1) Clock Timing	Deleted all information about the HCLK1 pin and the HCLK2 pin in the table.
54		Deleted the HCLK1 pin and the HCLK2 pin in the “ Input waveform generated when an external clock (main clock) is used”. Deleted the external connection diagram for the HCLK1 pin and the HCLK2 pin in “ Figure of main clock input port external connection”.

NOTE: Please see “Document History” about later revised information.